

SE20DB, SE20DD, SE20DG, SE20DJ

Vishay General Semiconductor

RoHS

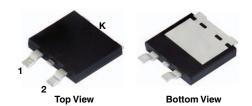
COMPLIANT

HALOGEN

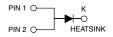
FREE

Surface Mount ESD Capability Rectifiers

eSMP[®] Series TO-263AC (SMPD)



SE20DX



PRIMARY CHARACTERISTICS						
I _{F(AV)}	20 A					
V_{RRM}	100 V, 200 V, 400 V, 600 V					
I _{FSM}	150 A					
V_F at I_F = 20 A (T_A = 125 °C)	1.03 V					
I _R	25 μΑ					
T _J max.	175 °C					
Package	TO-263AC (SMPD)					
Diode variations	Single					

FEATURES

- Very low profile typical height of 1.7 mm
- · Ideal for automated placement
- Oxide planar chip junction
- Low forward voltage drop
- ESD capability
- AEC-Q101 qualified
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

General purpose, power line polarity protection, in both consumer and automotive applications.

MECHANICAL DATA

Case: TO-263AC (SMPD)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and

commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable

J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: As marked

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)							
PARAMETER	SYMBOL	SE20DB	SE20DD	SE20DG	SE20DJ	UNIT	
Maximum repetitive peak reverse voltage	V_{RRM}	100	200	400	600	V	
Maximum DC forward current	I _F ⁽¹⁾	20				Α	
Maximum DC forward current	I _F ⁽²⁾	3.9					
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	150			А		
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +175			°C		

Notes

(1) With heatsink

(2) Free air, mounted on recommended copper pad area



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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 10 A	T _A = 25 °C		0.98	-	V
	I _F = 20 A		V _F (1)	1.10	1.20	
	I _F = 10 A	- T _A = 125 °C	v _F ('')	0.88	-	
	I _F = 20 A			1.03	1.15	
Reverse current	Rated V _R	T _A = 25 °C	I _R ⁽²⁾	-	25	μА
	nated V _R	T _A = 125 °C	IR (=)	38	150	
Typical reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$		t _{rr}	3000	-	ns
Typical junction capacitance	4.0 V, 1 MHz		CJ	150	-	pF

Notes

 $\stackrel{(1)}{\sim}$ Pulse test: 300 μs pulse width, 1 % duty cycle $\stackrel{(2)}{\sim}$ Pulse test: Pulse width $\leq 40~ms$

THERMAL CHARACTERISTICS (T _A = 25 °c unless otherwise noted)							
PARAMETER	SYMBOL SE20DB SE20DD SE20DG SE20DJ UNIT						
Typical thermal resistance	R _{0JA} (1)	60				°C/W	
Typical thermal resistance	R _{0JM} (2)	1.6				C/VV	

 $^{(1)}$ Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance $R_{\theta JA}$ - junction to ambient

(2) With heatsink

IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS ($T_A = 25~^{\circ}\text{C}$ unless otherwise noted)						
STANDARD	TEST TYPE	TEST CONDITIONS	SYMBOL	CLASS	VALUE	
AEC-Q101-001	Human body model (contact mode)	C = 100 pF, R = 1.5 kΩ	V _C	НЗВ	> 8 kV	

ORDERING INFORMATION (Example)						
STANDARD	PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
TO-263AC (SMPD)	SE20DJ-M3/I	0.54	I	2000/reel	13" diameter plastic tape and reel	
TO-263AC (SMPD)	SE20DJHM3/I ⁽¹⁾	0.54	I	2000/reel	13" diameter plastic tape and reel	

Note

(1) AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

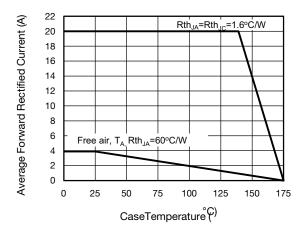


Fig. 1 - Forward Current Derating Curve

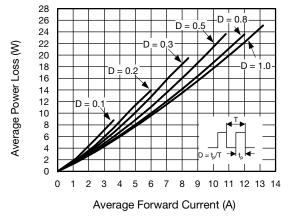


Fig. 2 - Forward Power Loss Characteristics

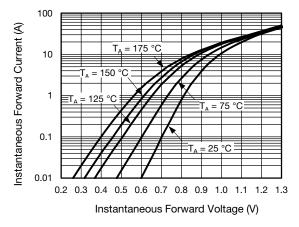


Fig. 3 - Typical Instantaneous Forward Characteristics

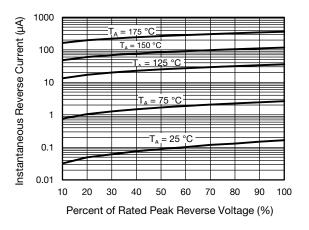


Fig. 4 - Typical Reverse Leakage Characteristics

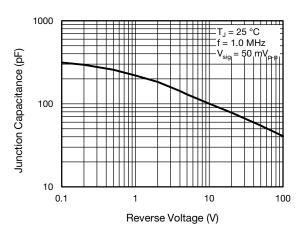


Fig. 5 - Typical Junction Capacitance

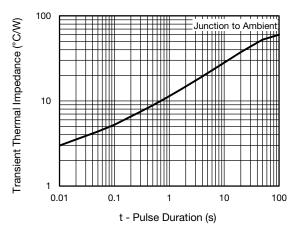
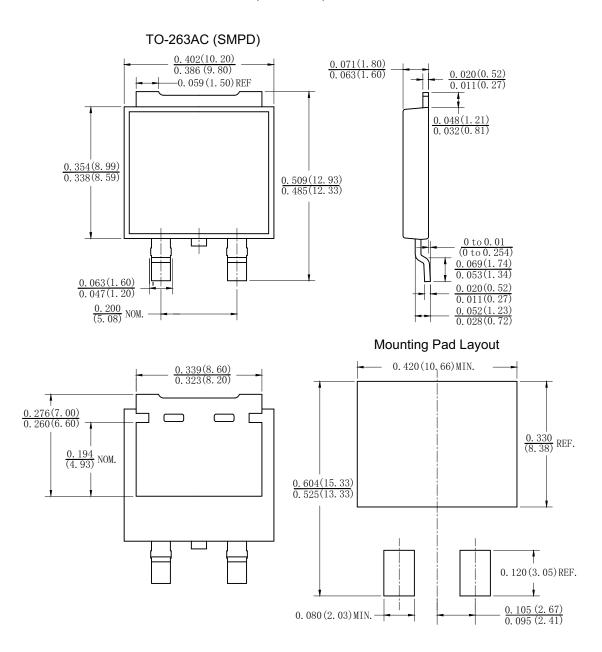


Fig. 6 - Typical Transient Thermal Impedance



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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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